

N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET

**General Description** 

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that

incorporates Shielded Gate technology. This process has been

# **Thermal Characteristics**

FAIRCHILD

**FDMS86201** 

**Features** 

**120 V, 49 A, 11.5 m**Ω

Shielded Gate MOSFET Technology

• Max  $r_{DS(on)}$  = 11.5 m $\Omega$  at V<sub>GS</sub> = 10 V, I<sub>D</sub> = 11.6 A

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		1.2	°C/W
Rein	Thermal Resistance, Junction to Ambient	(Note 1a)	50	°C/w

## **Package Marking and Ordering Information**

Device Marking Device		Package	Reel Size	Tape Width	Quantity
FDMS86201	FDMS86201	Power 56	13 "	12 mm	3000 units

D

D

D

D

Units

V

V

А

mJ

W

°C

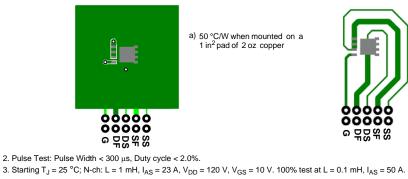
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FDMS86201 N	
N-Channel	
Shielded (	
<b>V-Channel Shielded Gate PowerTrench<sup>®</sup></b>	
	)
MOSFET	

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V				V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		95		mV/°C
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 96 V, V <sub>GS</sub> = 0 V			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current, Forward	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250 μA	2.0	2.6	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-10		mV/°C
	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 11.6 A		9.6	11.5	
r <sub>DS(on)</sub>		$V_{GS} = 6 \text{ V}, I_D = 10.7 \text{ A}$ 11.8				mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 11.6 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		15.7	21.5	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 11.6 A		39		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance			2056	2735	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V, f = 1 MHz		322	430	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			15	25	pF
R <sub>g</sub>	Gate Resistance			1.2		Ω
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			13	24	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 60 V, I <sub>D</sub> = 11.6 A,		7.7	16	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		27	44	ns
t <sub>f</sub>	Fall Time	1 – – – – – – – – – – – – – – – – – – –		7.1	15	ns
Qg	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		32	46	nC
Qg	Total Gate Charge	$V_{GS} = 0 \text{ V to 5 V} \text{V}_{DD} = 60 \text{ V},$		18	26	nC
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 11.6 A		8.1		nC
	Gate to Drain "Miller" Charge			7.1		nC

V <sub>SD</sub> Source to Drain Diode Forward Voltage	Source to Drain Diado, Forward Voltage	$V_{GS} = 0 V, I_{S} = 2 A$	(Note 2)	0.69	1.2	V	
	$V_{GS} = 0 V, I_{S} = 11.6 A$	(Note 2)	0.78	1.3	v		
t <sub>rr</sub>	Reverse Recovery Time	$I_{\rm E} = 11.6 \text{A. di/dt} = 100 \text{A/us}$		66	106	ns	
Q <sub>rr</sub>	Reverse Recovery Charge			88	140	nC	

Notes: 1. R<sub>8JA</sub> is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>8JC</sub> is guaranteed by design while R<sub>8CA</sub> is determined by the user's board design.

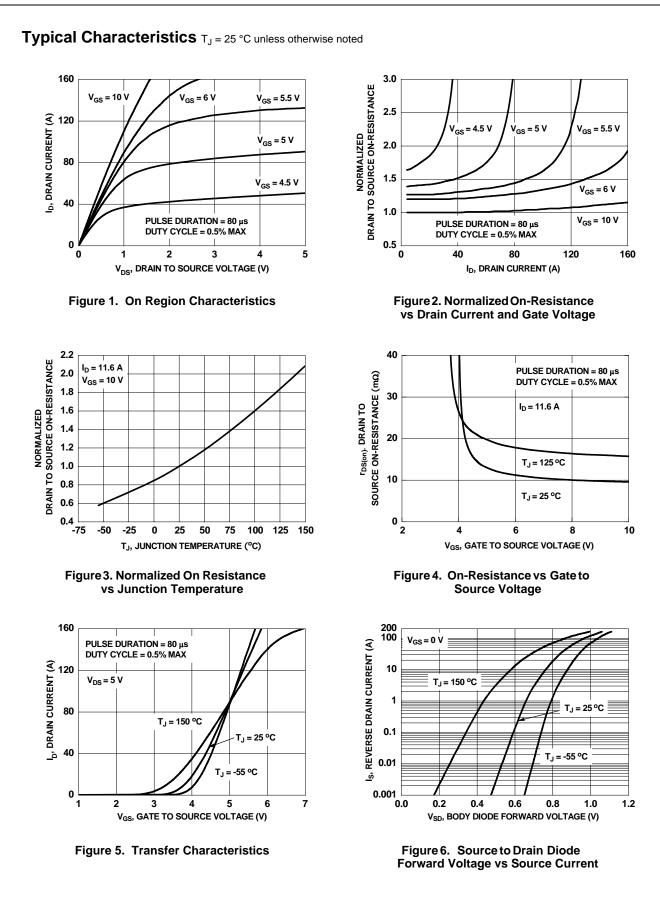


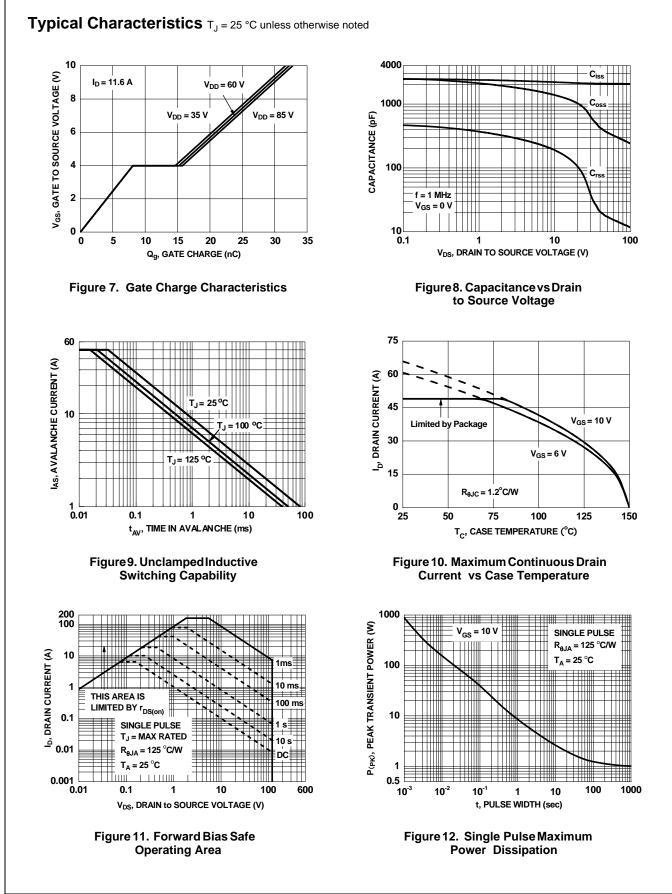
a) 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



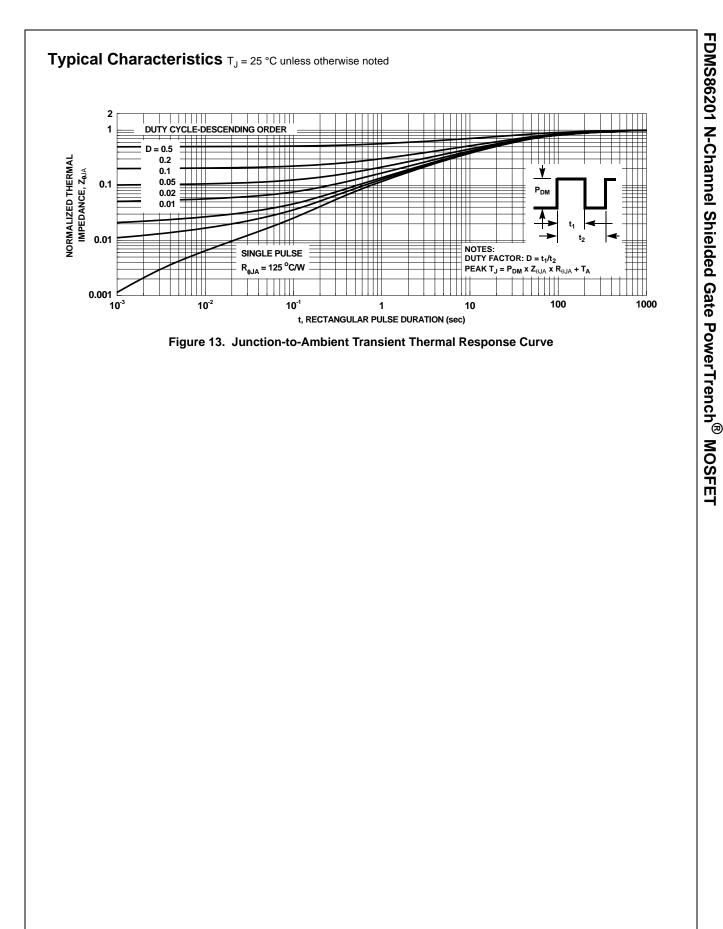
b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

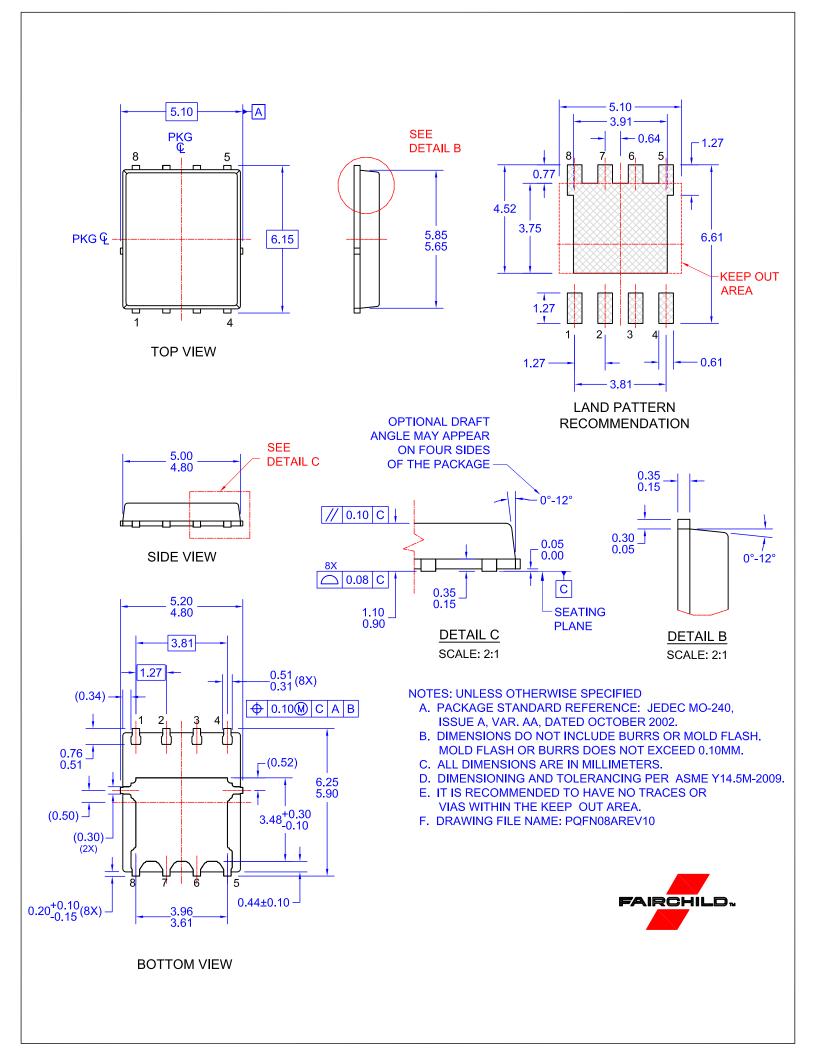
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FDMS86201 N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET







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